



Allwinner Technology
eMMC/tSD/fSD Support List
V1.0



- Note Introduction

IC Platform	SDK Version	SD/eMMC Driver Version
A20	Homlet A20 Android4.2.2 SDK V2.1	V1.6

Note	Description
D/S	Datasheet Support but no sample test
S/T	Support and sample test
√	Support and mass produce
X	Not support

- Attention

This support list is based on the latest SD/eMMC driver version.



• Support List

Vendor	Capacity (B)	Part Number	eMMC/SD	Cell & Process	Pkg Size (mm)	A20	Remark
						HOMLETSKD2.1	
Samsung	8G	KLM8G1WE4A-A001	v4.41		12*16-BGA169	S/T	
	16G	KLMAG2WE4A-A001	v4.41		12*16-BGA169	S/T	
	4G	KLM4G1FE3B-B001	v4.41		11.5*13-BGA153	S/T	
	4G	KLM4G1YEMD-B031	v5.0	TLC/19nm	11.5*13-BGA153	S/T	
	8G	KLM8G1WEMB-B031	v5.0	TLC/19nm	11.5*13-BGA153	S/T	
	16G	KLMAG2WEMB-B031	v5.0	TLC/19nm	11.5*13-BGA153	S/T	
	32G	KLMBG4WEBC-B031	v5.0	TLC/19nm	11.5*13-BGA153	S/T	
	16G	KLMAG2GEAC-B031	v5.0	MLC/19nm	11.5*13-BGA153	D/S	
	8G	KLM8G1GEAC-B031	v5.0	MLC/19nm	11.5*13-BGA153	D/S	
	4G	KLM4G1FEAC-B031	v5.0	MLC/19nm	11*10-BGA153	D/S	
	32G	KLMBG4GEAC-B031	v5.0	MLC/19nm	11.5*13-BGA153	D/S	
Sandisk	8G	SDIN7DP2-8G	v4.5		11.5*13-BGA153	S/T	
	16G	SDIN7DU2-16G	v4.41		11.5*13-BGA153	✓	
	4G	SDIN7DP2-4G	v4.5		11.5*13-BGA153	S/T	
	8G	SDIN8DE1-8G	v4.5	MLC/19nm	11.5*13-BGA153	S/T	
	8G	SDIN8DE2-8G	v4.5	MLC/19nm	11.5*13-BGA153	S/T	
	8G	SDIN8DR1-8G	v4.51	TLC/1Ynm	11.5*13-BGA153	S/T	
	16G	SDIN8DR1-16G	v4.51	TLC/1Ynm	11.5*13-BGA153	S/T	
	4G	SDIN8DE2-4G	v4.51	MLC/19nm	11.5*13-BGA153	S/T	
	16G	SDIN8DE4-16G	v4.51	MLC/19nm	11.5*13-BGA153	D/S	
	16G	SDIN8DE2-16G	v4.51	MLC/19nm	11.5*13-BGA153	D/S	



Vendor	Capacity (B)	Part Number	eMMC/SD	Cell & Process	Pkg Size (mm)	A20	Remark
						HOMLETSKD2.1	
Sandisk	32G	SDIN8DE4-32G	v4.51	MLC/19nm	11.5*13-BGA153	D/S	
	16G	SDIN9DW4-16G	v5.0	MLC/19nm	11.5*13-BGA153	D/S	
	32G	SDIN9DW4-32G	v5.0	MLC/19nm	11.5*13-BGA153	D/S	
Micron	4G	3EA28-JW878 (MTFC4GLWAM-WT)	v4.5		11.5*13-BGA153	S/T	
	8G	3CA28-JW879 (MTFC8GLWAM-WT)	v4.5		11.5*13-BGA153	S/T	
	4G	1UA18-JW729 (MTFC4GMTEA-WT)	v4.41		11.5*13-BGA153	S/T	
	8G	2GA28-JW686 (MTFC8GLSEA-IT)	v4.41		11.5*13-BGA153	S/T	
	8G	3ZA28-JWA48 (MTFC8GACAAEA-WT)	v4.51	MLC	11.5*13-BGA153	S/T	
	4G	3ZA28-JWA49 (MTFC4GACAAEA-WT)	v4.51	MLC	11.5*13-BGA153	S/T	
Toshiba	4G	THGBM5G5A1JBAIR	v4.5	MLC/19nm	11.5*13-BGA153	√	
	8G	THGBM5G6A2JBAIR	v4.5	MLC/19nm	11.5*13-BGA153	S/T	
	16G	THGBMAG7A2JBAIR	v4.5		11.5*13-BGA153	S/T	
	4G	THGBMAG5A1JBAIR	v4.5	MLC/19nm	11.5*13-BGA153	S/T	
	16G	THGBMBG7D4KBAIR	v5.0		11.5*13-BGA153	S/T	
	32G	THGBMBG8D4KBAIR	v5.0	MLC/A19nm	11.5*13-BGA153	S/T	
	8G	THGBMBG6D1KBAIL	v5.0	MLC/A19nm	11.5*13-BGA153	S/T	
	16G	THGBMBG7D2KBAIL	v5.0	MLC/A19nm	11.5*13-BGA153	S/T	
	16G	THGBM5G7A2JBAIR	v4.5	MLC/19nm	11.5*13-BGA153	S/T	



Vendor	Capacity (B)	Part Number	eMMC/SD	Cell & Process	Pkg Size (mm)	A20	Remark
SKhynix	4G	H26M31003GMR	v4.51	MLC/20nm	11.5*13-BGA153	S/T	
	8G	H26M42003GMR	v4.51	MLC/20nm	11.5*13-BGA153	S/T	
	16G	H26M52003EQR	v4.51	MLC/20nm	12*16-BGA169	S/T	
	8G	H26M41103HPR	v5.0	MLC/16nm	11.5*13-BGA153	S/T	
	16G	H26M52103FMR	v5.0	MLC/16nm	11.5*13-BGA153	S/T	
Kingston	4G	KE44B26BN	v4.41		12*16-BGA169	S/T	
	8G	KE4CV3H5A	v4.41		11.5*13-BGA153	S/T	
	16G	KE4CV4H5A	v4.41		11.5*13-BGA153	S/T	
	8G	KE4CN3K6A	v4.5		12*16-BGA169	S/T	
	4G	KE4CN2H5A	v4.5		11.5*13-BGA153	S/T	
	16G	KE4CN4K6A	v4.5		12*16-BGA169	S/T	
FORESEE	4G	NCTSTS86-04G	SD 2.0		12*20-TSOP48	S/T	tSD
	8G	NCTSTS76-08G	SD 2.0		12*20-TSOP48	S/T	tSD
	8GB	NCESES76-08G	v4.41		11.5*13.5-BGA153	S/T	
	16G	NCESES76-16G	v4.41		11.5*13.5-BGA153	S/T	
	4G	NCFSES86-04G	SD 2.0		11.5*13.5-BGA153	S/T	fSD
	8G	NCFSES76-08G	SD 2.0		11.5*13.5-BGA153	S/T	fSD
	4G	NCEFES76-04G	v4.41		11.5*13.5-BGA153	S/T	
BIWIN	8G	BWAMGTB11A08G	v4.51		12*16-BGA169	S/T	
	16G	BWAMGTB21A16G	v4.51		12*16-BGA169	S/T	
AcSip	8G	NCMMCS08G	v4.5		12*16-BGA169	S/T	
	16G	NCMMCS16G	v4.5		12*16-BGA169	S/T	



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